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September 1983 Revised May 2005

MM74HC688 8-Bit Magnitude Comparator (Equality Detector)

General Description

The MM74HC688 equality detector utilizes advanced silicon-gate CMOS technology to compare bit for bit two 8-bit words and indicates whether or not they are equal. The $\overline{P=Q}$ output indicates equality when it is LOW. A single active low enable is provided to facilitate cascading of several packages and enable comparison of words greater than 8 bits.

This device is useful in memory block decoding applications, where memory block enable signals must be generated from computer address information. The comparator's output can drive 10 low power Schottky equivalent loads. This comparator is functionally and pin compatible to the 74LS688. All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

Features

- Typical propagation delay: 20 ns
- Wide power supply range: 2-6V
- Low quiescent current: 80 µA (74 Series)
- Large output current: 4 mA (74 Series)
- Same as HC521

Ordering Code:

Order Number	Package Number	Package Description
MM74HC688WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
MM74HC688SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC688MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC688N	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

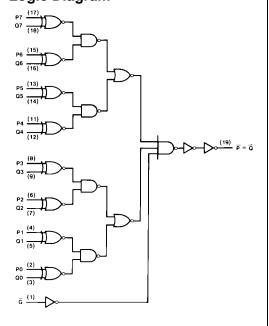
Connection Diagram

Pin Assignments for DIP VCC P = Q Q7 P7 Q6 P6 Q5 P5 Q4 P4 20 19 18 17 16 15 14 13 12 11 1 2 3 4 5 6 7 8 9 10 Top View

Truth Table

Inp		
Data	Enable	
P,Q	G	$\overline{P} = \overline{Q}$
P = Q	L	L
P > Q	L	Н
P < Q	L	Н
Х	Н	Н

Logic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

Cumply Voltogo (V/)	-0.5 to +7.0V
Supply Voltage (V _{CC})	-0.5 to +7.0V
DC Input Voltage (V _{IN})	-1.5 to V_{CC} +1.5 V
DC Output Voltage (V _{OUT})	-0.5 to V_{CC} $+0.5V$
Clamp Diode Current (I _{IK} , I _{OK})	±20 mA
DC Output Current, per pin (I _{OUT})	±25 mA
DC V _{CC} or GND Current, per pin (I _{CC})	±50 mA
Storage Temperature Range (T _{STG})	-65°C to +150°C
Power Dissipation (P _D)	
(Note 3)	600 mW

S.O. Package only Lead Temperature (T_L)

(Soldering 10 seconds)

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T_A)	-40	+85	°C
Input Rise or Fall Times			
$(t_r, t_f) V_{CC} = 2.0V$		1000	ns
V _{CC} = 4.5V		500	ns
$V_{CC} = 6.0V$		400	ns

500 mW Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	v _{cc}	T _A = 25°C		T _A = -40 to 85 °C	T _A = -55 to 125°C	Units
Syllibol				Тур		Guaranteed L	imits	Units
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	V
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \leq 20~\mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or V_{IL}						-
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \leq 20~\mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \leq 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μА
	Current							
I _{CC}	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND	6.0V		8.0	80	160	μА
	Supply Current	$I_{OUT} = 0 \mu A$						

260°C

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage cur- ${\rm rent}\; (I_{IN},I_{CC}, {\rm and}\; I_{OZ}) \; {\rm occur}\; {\rm for}\; CMOS \; {\rm at}\; {\rm the}\; {\rm higher}\; {\rm voltage}\; {\rm and}\; {\rm so}\; {\rm the}\; 6.0V \; {\rm values}\; {\rm should}\; {\rm be}\; {\rm used}.$

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

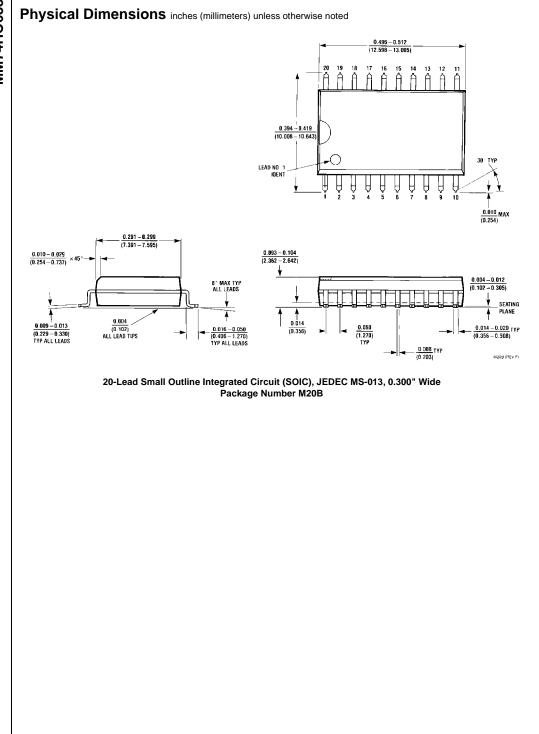
Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation		21	30	ns
	Delay, any P or Q to Output				
t _{PLH} , t _{PHL}	Maximum Propagation		14	20	ns
	Delay, Enable to any Output				

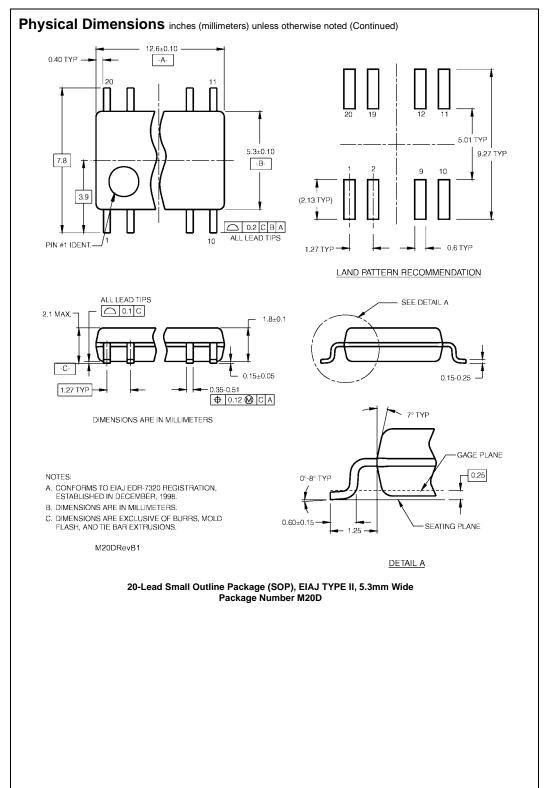
AC Electrical Characteristics

 $V_{CC} = 2.0 \text{V}$ to 6.0V, $C_L = 50 \text{ pF}$, $t_r = t_f = 6 \text{ ns}$ (unless otherwise specified)

Symbol	Parameter	Conditions	v _{cc}	T _A = 25°C		T _A = -40 to 85°C	T _A = -55 to 125°C	Units	
			•66	Typ Guaranteed Limits			imits	Ullits	
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	60	175	220	263	ns	
	Delay, P or Q to		4.5V	22	35	44	53	ns	
	Output		6.0V	19	30	38	45	ns	
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	45	120	150	180	ns	
	Delay, Enable to		4.5V	15	24	30	36	ns	
	Output		6.0V	13	20	25	30	ns	
t _{THL} , t _{TLH}	Maximum Output Rise		2.0V	30	75	95	110	ns	
	and Fall Time		4.5V	8	15	19	22	ns	
			6.0V	7	13	16	19	ns	
C _{PD}	Power Dissipation			45				pF	
	Capacitance (Note 5)								
C _{IN}	Maximum Input			5	10	10	10	pF	
	Capacitance								

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC}^f + I_{CC}$.





NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.

DIMENSIONS ARE IN MILLIMETERS

- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REVD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

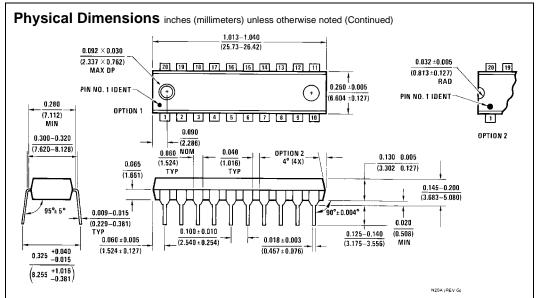
R0.09min

-0.6±0.1-

GAGE PLANE

R0.09min

DETAIL A



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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